

Modeling of the Mechanical Responses of Nanocrystalline Metals and Alloys

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Abstract— This paper reports the proposed model of the flow behaviors of nanocrystalline metals and alloys deformed at different strains, strain rates and temperatures. It incorporated the effect of grain size, high internal stresses and lattice distortions existing near boundaries to the Hall-Petch relations. The developed model was compared to that of Khan-Huang-Liang and found to be more reliable in clarifying the inverse Hall-Petch relation. Using the new proposed constitutive model, the mechanical behaviour of materials at different grain sizes for ultrafine grained to nanostructure materials at different temperatures and strain rates can be obtained. The model is also useful in predicting the response of nanocrystalline metals and alloys during the forming process.

Keywords— grain boundaries; grain size; Hall-Petch equation; nanocrystalline; volume fraction; yield stress;

I. INTRODUCTION

Nanocrystalline metals and alloys have been attracting growing scientific and industrial interest in the last decade due to their novel and attractive properties [1- 4]. They are materials with a polycrystalline structure characterized primarily by fine microstructures with grain size that is less than 100 nm [5]. In terms of mechanical properties, they have been found to exhibit extraordinary high yield strengths, high hardness and improved toughness [1]. They also exhibit good ductility with increasing strain rate, which are potentially superior to coarse-grained materials. The yield strength dependence on the grain size for polycrystalline materials follows the Hall-Petch

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relationship in equation (1):

$$\sigma_y = \sigma_o + \frac{K}{\sqrt{D}} \quad (1)$$

where σ_y is the yield stress, K is the material constant, σ_o is the frictional stress, that is, the Hall-Petch slope, and D is the grain size [6,7] for materials with a normal grain size morphology. From this relationship, the yield strength of a polycrystalline material is expected to increase with a decrease in the grain size. However, for some metallic materials, when the grain size is very fine (<10 nm) a reversed softening effect (also known as the inverse Hall-Petch relation) is observed [8-10]. This limits the reliability of the Hall-Petch relationship to predict the strength of polycrystalline materials at a nano-scale. Numerous studies have been carried out to clarify the inverse Hall-Petch relation [11- 13]. It is concluded that as the size of the crystalline grains reduce into the nanometer range, the volume fraction of the grain boundaries and triple junctions increase rapidly and consequently, the activities of the grain boundaries increases [14,15] and the influence of the grain boundaries can be very important [16]. The literature is limited in this field of study, yet significant in the field of microstructural evolution. The authors therefore, propose a model which is capable of predicting the flow behaviors of nanocrystalline metals and alloys deformed at different strains, strain rates and at varied temperatures.

II. PHENOMENOLOGICAL CONSTITUTIVE MODEL

A phenomenological model is a classical approach for modelling the material behaviours where the macroscopic mechanical test results are fitted to a convenient mathematical function. Many phenomenological constitutive models are widely used in the simulation of the forming processes of metals and alloys at high strain rates and temperatures [17] such as Johnson Cook (JC) [18], Khan-Huang (KH) [19] and Khan-Huang-Liang (KHL) [20, 21]. among others. The common features of these models are that they can be expressed as a function of the forming temperature, strain rate and strain to consider the effects of these forming parameters on the flow behaviours of metals and alloys.

The JC constitutive model is presented in equation 2:

$$\sigma = \sigma(\epsilon, \dot{\epsilon}, T) \quad (2)$$

Where σ is flow stress, ϵ is strain $\dot{\epsilon}$ is strain-rate and T

is temperature,

The Johnson-Cook (JC) constitutive model [18] is widely known as a forming temperature, strain and strain-rate dependent phenomenological flow stress model, and has been successfully applied to a variety of materials with different ranges of deformation temperature and strain-rate. This model assumes that materials are isotropic, to avoid the traditional concept of yield surface in constitutive equation.

Introduce equation 3:

$$\sigma = (A + B \varepsilon^n) \left(1 + C \ln \dot{\varepsilon} \right) \left(1 - T^{*m} \right) \quad (3)$$

Where σ is the equivalent flow stress, ε is the equivalent plastic strain, A is the yield stress at reference temperature and reference strain-rate, B is the coefficient of strain-hardening, n is the strain hardening exponent, C and m are the material constants which represent the coefficient of strain-rate hardening and thermal softening exponent, respectively. T^* is the homologous temperature and expressed as,

$$T^* = \frac{T - T_r}{T_m - T_r} \quad (4)$$

T is the temperature, T_m is the melting temperature, T_r is the reference temperature

Therefore, the model has enjoyed much success because of its simplicity and the availability of parameters for various materials [17].

A lot of modifications have been made to the Johnson Cook model. Zhang *et al.* [22] modified the original JC model by studying the effects of forming temperature on strain-hardening behaviour for IC10 alloy. The final modification of Johnson Cook model by Zhang *et al* is expressed as:

$$\sigma = \left[A \left(1 - T^{*m} \right) + B \left(T^* \right) \varepsilon^n \right] \left(1 + C \ln \dot{\varepsilon} \right) \quad (5)$$

Where; $\sigma, \varepsilon, \dot{\varepsilon}, T^*$ are same as the original Johnson Cook model. In equation 5, $B(T^*)$ is a function of T^* and can be determined as

$$B(T^*) = \frac{\sigma_{br} \left(1 - T^{*m_1} \right) - \sigma_{0.2r} \left(1 - T^{*m} \right)}{\left(\varepsilon_{br} \left(1 + P_1 \times T^* - P_2 \times T^{*P_3} \right) \right)^n} \quad (6)$$

Where; m_1, P_1, P_2 and P_3 are material constants, σ_{br} is broken stress at room temperature and reference strain-rate, ε_{br} is the broken strain at room temperature and reference strain-rate. The variation of the yield stress is asynchronous with the variation of the hardening component when temperature is changed.

Lin *et al* [23] also proposed a model by modifying the JC model. They considered the yield and strain hardening portions of the original JC model and the coupling effects of the temperature and strain rate on the flow behaviors for the alloy steel. The Lin *et al* model is presented in equation 7:

$$\sigma = \left(A_1 + B_1 \varepsilon + B_2 \varepsilon^2 \right) \left(1 + C \ln \dot{\varepsilon} \right) \exp \left[\left(\lambda_1 + \lambda_2 \ln \dot{\varepsilon} \right) \left(T - T_r \right) \right] \quad (7)$$

Where; $A_1, B_1, B_2, C, \lambda_1, \lambda_2$ are the material constants, the

meanings of $\sigma, \varepsilon, \dot{\varepsilon}, T, T_r$ are identical to those of the original JC model. Hou and Wang [24] also modified JC models shown in equations 8 and 9:

$$\sigma = \left(\sigma_0 + B \varepsilon^n \right) \left(1 + C \log_{10} \dot{\varepsilon} \right) e^{-\lambda_1} \left(T - T_r \right) \quad (8)$$

$$\sigma = \sigma_0 \left(1 + C_2 \ln \dot{\varepsilon} \right) + B \varepsilon^n \left(1 + C_2 \ln \dot{\varepsilon} \right) e^{-\lambda_1} \left(T - T_r \right) \quad (9)$$

Where; σ_0 is the initial yield stress, $B, C, C_1, C_2, \lambda_1$ and λ_2 are the material constants.

This equation could study the plastic response of the body-centered cubic (BCC) [25] and face centered cubic (FCC) [26] metals, but are not suitable to study the plastic response of the Hexagonal close packed (HCP) Magnesium alloys. So, Hou and Wang [24] proposed another modified JC constitutive model, as shown in Equation.10, to study the plastic response of the hot-extruded Mg-10Gd-2Y-0.5Zr alloy over a wide range of temperatures.

$$\sigma = \left(A + B \varepsilon^n \right) \left(1 + C \log_{10} \dot{\varepsilon} \right) \left(1 - \lambda \frac{e^{T/T_m}}{e - e^{T_r/T_m}} \right) \quad (10)$$

Where the meaning of $A, B, \varepsilon, n, C, T, T_m \sim 610^\circ\text{C}$ for the Mg-10Gd-2Y-0.5Zr alloy and T_r are the same as the original JC model, and λ is the material constant. The model shows a good agreement between the experimental data and the modified JC model correlations for the hot extruded Mg-10Gd-2Y-0.5Zr alloy to predict the plastic response of the hot-extruded Mg-10Gd-2Y-0.5Zr alloy under both quasi-static and a wide range of temperatures even though the current temperatures were lower than the reference temperature.

A constitutive model to predict the work hardening behaviour at large strain rates range for 1100 Aluminum on the approximation of isotropic hardening during large deformation was proposed by Khan and Huang in the 1990s [15,19]. They incorporated the Hall-Petch relation into the KH model to introduce the yield-stress dependence on the grain size and the KHL constitutive model was modified to include grain size dependence, work hardening, rate sensitivity and temperature effect to present the behaviour of fully compacted nanocrystalline iron. The material behaviour of iron with grain size in nm was described by generalized Hookes law before yielding, while the KHL model, modified by grain size effect, is used to reflect the stress/strain behaviour after yielding as per Equation 5

$$\sigma = \left(a_0 + \frac{k_0}{\sqrt{D}} \right) \left[1 + B \left(1 - \frac{\ln \varepsilon}{\ln D_0^p} \right)^{ni} (\dot{\varepsilon})^{no} \left(\frac{\varepsilon}{\varepsilon_*} \right)^C \left[\frac{T_M - T}{T_M - T_r} \right]^m \right] \quad (11)$$

Where; B, no, ni, C, m are the material constants, T is the

temperature, T_m is the melting temperature, T_r is the reference temperature, D_o^p is the plastic deformation rate (is

taken to be 10^6 s^{-1}) $\dot{\epsilon}$ is current strain and $\dot{\epsilon}_* = 1 \text{ s}^{-1}$ is the reference strain rate. Khan *et al.*²¹ showed that the first term from equation 11 can be used for all grain size. The remaining of the equation retains its original form and relates the strain hardening to the strain, strain rate, and temperature [27, 28].

III. THE PROPOSED CONSTITUTIVE MODEL

High Resolution Transmission Electron Microscopy (HRTEM) studies have shown that the local atomic structure of grain boundaries in nanostructure materials is similar to that in coarse grained metals, except that high internal stresses and lattice distortions exist near boundaries nanostructured materials [11, 29, 30]. Stress-type threshold behaviour for grain boundary deformation was considered in past works [8,31], They considered a constant value for the yield strength of the grain boundary as k^* . The general equation for yielding can be written as per equations 12 and 13.

$$(\sigma_{gb}) = k^* \quad (12)$$

$$\sigma = k^* f_{gb} + \sigma_g f_g - \sigma_{in} f_{gb} \quad (13)$$

Where σ is the flow stress, σ_{gb} is the grain boundary stress, σ_{in} is the internal stress along grain boundary, f_{gb} is the volume fraction of the grain boundary, f_g is the volume fraction of the crystalline part, σ_g stress at the grain. In order to incorporate the volume fraction into yield stress, we substitute $f_g = (1 - f_{gb})$ into equation 13 and obtain equation 14

$$\sigma = \sigma_g + (k^* - \sigma_g) f_{gb} - \sigma_{in} f_{gb} \quad (14)$$

For coarse grain materials, the third item is very small and can be ignored, so that the first two terms of equation 15 is compared with Hall-Petch equation [32].

$$\sigma_g = \sigma_o, \quad (k^* - \sigma_g) f_{gb} = \frac{K}{\sqrt{D}} \quad (15)$$

Equation 1 can now be rewritten as

$$\sigma_y = a_o + \frac{k_o}{\sqrt{D}} - \sigma_{in} f_{gb} \quad (16)$$

Where a_o is the frictional stress and k_o is the material constant obtained from the experiment. The formula shows that the grains are in nano- size and f_{gb} is noticeable.¹⁶

The f_{gb} can be calculated from

$$f_{gb} = 1 - \left(1 - \frac{w}{D}\right)^3 \quad (17)$$

Where w is the width of grain boundary. σ_{in} can be calculated from

$$\sigma_{in} = G_g \cdot \gamma_g = \frac{2G_g \cdot \delta}{D} \quad (18)$$

Where G_g is shear modulus of grain next to grain boundaries, γ_g is the shear strain within the grains but adjacent to grain boundaries, (16) and it can be calculated using equation 19:

$$\gamma_g = \frac{2\delta}{D} \quad (19)$$

Where δ represents the distance of mismatch or distortion in grains, but in the vicinity of grain boundaries that is equal to half of the inter-planar distance or half of the grain boundaries.

In this work, Khan-Huang-Liang (KHL) model was modified by incorporating the effect of grain boundaries and the volume fraction of grain boundaries for nanocrystalline metals and alloys (21). It is assumed that when grains are in nano size and the volume fraction is noticeable, it is not the size of crystalline grain, the grain boundary condition also contributes to the yield stress and the lattice distortion along the grain boundaries can cause internal stresses. The constitutive equation used in formulation of the model is Johnson Cook model (18) and Khan-Huang-Liang model (19, 20). The models are coupled with the new model for inverse Hall-Petch equation that is observed for some materials, when the grain size is significantly below the micrometer range and where internal stresses along grain boundaries are assumed to strongly change, the yield strength of the nanocrystalline materials were taken into account. This phenomenological constitutive model is proposed to simulate the unique features of these materials and is presented in equation 20:

$$\sigma = \left(a_o + \frac{k_o}{\sqrt{D}} - \sigma_{in} f_{gb} \right) \left[1 + B \left(1 - \frac{\ln \dot{\epsilon}}{\ln D_o^p} \right)^{ni} (\dot{\epsilon})^{no} \right] \left(\frac{\dot{\epsilon}}{\dot{\epsilon}_*} \right)^C \left[\frac{T_M - T}{T_M - T_r} \right]^m \quad (20)$$

The parameters a_o and k_o are determined from the intercept and slope of the yield stress and grain size relation respectively.

Using this proposed constitutive model, the mechanical responses of materials at different grain sizes for coarse grain, ultrafine grained to nanostructure materials at different temperatures and strain rates can be obtained. The newly developed model has been employed to make some interesting and useful predictions about the effect of grain structure, the strain rate and the temperature used in the experiment. The results are compared to those predicted using Khan-Huang-Liang model. The numerical simulations results were conducted and the constant used for simulation are tabulated in Table 1 where nanocrystalline copper was used as a bench mark.

Table 1: The materials constant for nanocrystalline copper

a_0	169.7
k_0	3537.
B	3642.5
n^0	0.516
n^1	-0.81
C	0.02
f_{gb}	.0.711
σ_{in}	1700
D_o^p	106
m	1.53

IV. NUMERICAL SIMULATION RESULTS AND DISCUSSION

The comparison of the yield strength and various grain sizes by Khan-Huang-Liang model and the proposed model are plotted. Figures 1 and 2 show the results of the yield stress vs grain size at various temperatures using Khan-Huang-Liang model and the new proposed model at a strain rate of $10^{-2}s^{-1}$.

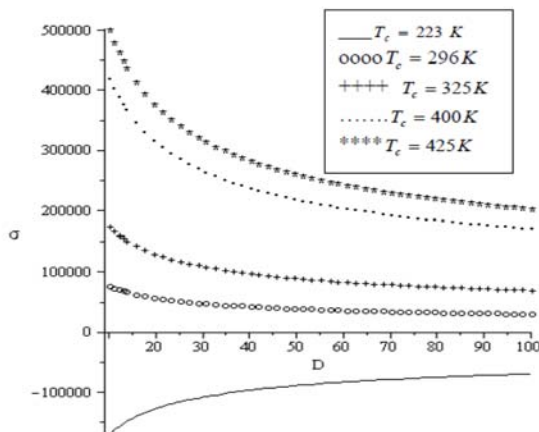


Figure 1: The stress profiles generated by the Khan-Huang-Liang simulated at different temperatures with $\dot{\epsilon} = 10^{-2}s^{-1}$

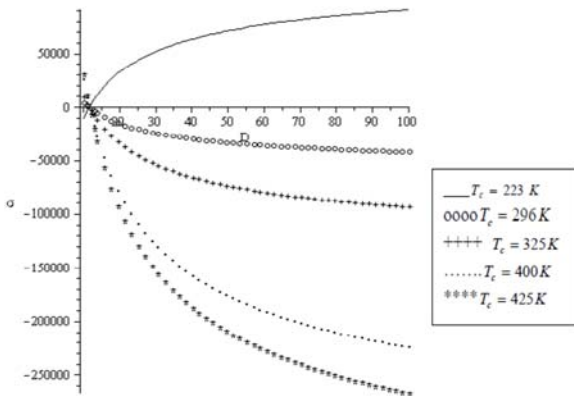


Figure 2: The stress profiles generated by the proposed model simulated at different temperatures with $\dot{\epsilon} = 10^{-2}s^{-1}$,

$$\sigma_{in}=1700 \text{ Mpa}, f_{gb} = 0.711$$

The yield stress of the nanocrystalline materials drop sharply at high temperatures 425-400 K and stabilized when the grain size is around 50 nm. At the lower temperatures 325-296 K and stabilized around 30nm for the Khan-Huang-Liang model, and for the proposed model it shows that the yield strength of the nanocrystalline material was reduced due to the internal stress along the grain boundaries and the effects of grain volume fraction along the grain boundary. At high temperatures 573-425 K the yield strength of the nanocrystalline materials was low.

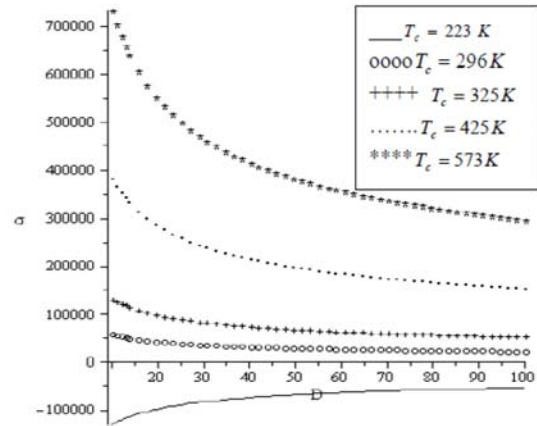


Figure 3: The stress profiles generated by the Khan-Huang-Liang simulated at different temperatures with $\dot{\epsilon} = 10^{-4}s^{-1}$

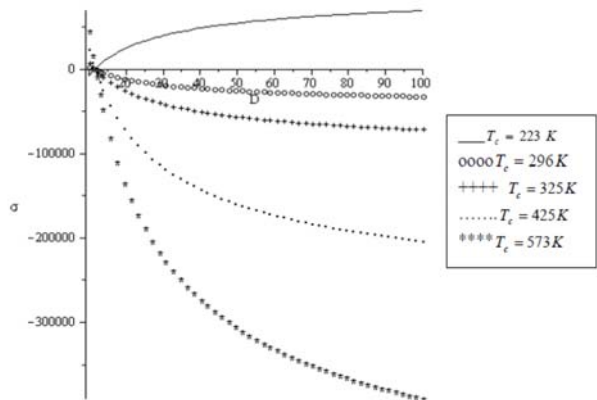


Figure 4: The stress profiles generated by the proposed model simulated at different temperatures with $\dot{\epsilon} = 10^{-4}s^{-1}$

$$\sigma_{in}=1700 \text{ Mpa}, f_{gb} = 0.711$$

At the strain rate of $10^{-4}s^{-1}$. The yield stress vs the grain sizes take the same pattern as when they are simulated at $\dot{\epsilon} = 10^{-2}s^{-1}$ see fig.3 and fig.4 and for the proposed model when simulated at lower temperatures (296-223K) the yield strength of the materials improve at various grain size. The yield strength was stabilizes when the grain size is around 50-60nm at the lower temperatures.

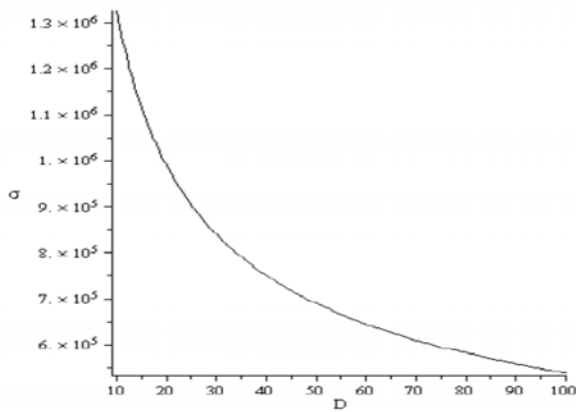


Figure 5: The stress profiles generated by the Khan-Huang- Liang that are simulated at temperatures with $\dot{\epsilon} = 10^4 \text{ s}^{-1}$ at $T_c = 400\text{K}$

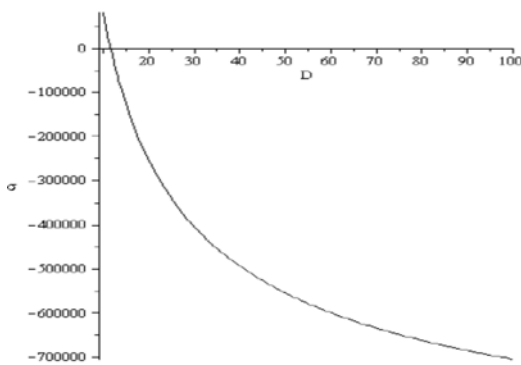


Figure 6: The stress profiles generated by the proposed model that are simulated at different temperatures with $\dot{\epsilon} = 2470 \text{ s}^{-1}$, $T_c = 400\text{K}$, $\sigma_{in} = 1700 \text{ Mpa}$, $f_{gb} = 0.711$

At high strain rate of 2470 s^{-1} increase in yield strength is observed as the grain size is decreased at a temperature of 400K . Comparing the result with the proposed model it shows that the yield strength of the nanocrystalline material was reduced due to the internal stress along the grain boundaries and the effects of grain volume fraction along the grain boundary. From the proposed model, one can conclude that the stress along the grain boundaries can affect the yield strength of nanocrystalline materials especially when the grain size is below 50 nm and leads to Inverse Hall-Petch effect. The developed model gives correlations with the experimental response of copper with grain size in nm . This can enhance understanding of the mechanical properties of other nanocrystalline materials.

V. CONCLUSION

A proposed model was used to explain the inverse Hall-Petch relation in nanocrystalline materials. The model showed that the internal stress along grain boundaries and volume fraction affected the yield strength of nanocrystalline materials. The model also predicts the response of nanocrystalline metals at different temperatures and strain rates especially at relatively high-strain-rate and different temperature conditions. From the results, it can be deduced that not only the size of crystalline grain, but also the boundary conditions contribute to the stress of the

yields. This model is a useful tool for predicting the flow behavior of nanocrystalline materials when the grain sizes are less than 10 nanometer . This model can also be used to understand some aspects of the Hall-Petch phenomenon which is still unclear in the study of nanocrystalline metals and alloys.

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